



APPLICATION FOR ENROLLMENT CLASS OF 2017

APPLICATIONS MUST BE POSTMARKED BY 8-31-16

MAIL:

Florida Engineering Leadership Institute
P.O. Box 750, Tallahassee, FL 32302

Overnight delivery: 125 South Gadsden Street, Ste. 100
Tallahassee, Florida 32301

FAX: 850/222-4349

EMAIL: kkeiffer@fleng.org

QUESTIONS? Contact Kathy M. Keiffer, CMP at 850/224-7121 or visit
<http://www.fleng.org/leadership.cfm>

II. EDUCATION

Degrees/Majors and Schools _____

List major leadership positions held or special honors. _____

III. EMPLOYMENT

Please use additional sheets of paper to answer the following questions. Please type your answers. Be sure to answer every question. Please duplicate the number and question you are answering with your response.

1. Briefly describe your current job responsibilities.
2. How many years have you been employed in an engineering-related field?
3. List previous employment in reverse chronological order (including active military duty). List employer, title/responsibilities, and beginning and ending dates.
4. Are you a member of the Florida Engineering Society (FES) or are you employed by a firm that is a member of the Florida Institute of Consulting Engineers (FICE)?
5. Business/professional affiliations (not including civic organizations, public office, or political activities). List name of group, position held or assignments, and the period of affiliation.
6. Please check one of the following categories that best describes your present employment:

Engineering

Other

IV. LEADERSHIP INVOLVEMENT

Please use additional sheets of paper to answer the following questions. Please type your answers. Be sure to answer every question. Please duplicate the number and question you are answering with your response.

1. Include state, community, civic, religious, political, government, social, athletic, or other activities. Do not include business/professional activities. Indicate major role in organization at this time. List significant involvement in these organizations with your assignment/position, and describe your responsibilities.
2. How did you exhibit leadership in one of the above organizations?
3. On the average, how much time each month do you commit to volunteer work?
4. In what kinds of additional statewide volunteer activities would you like to become active in the future?
5. If you have not had the time or interest to become actively involved, what conditions have changed that now enable you to seek involvement in your community and state?

V. REFERENCES

List name, title, business address and telephone number of two persons in leadership positions who can comment on your qualifications and of whom the Selection Committee may make inquiry.

Reference #1

Name _____

Title _____

Company/Firm _____

Mailing Address _____

City _____ State _____ Zip _____

Telephone _____

Florida Engineering Leadership Institute (FELI) Graduate? _____

Reference #2

Name _____

Title _____

Company/Firm _____

Mailing Address _____

City _____ State _____ Zip _____

Telephone _____

Florida Engineering Leadership Institute (FELI) Graduate? _____

VI. MISSION

To build a strong, diverse statewide network of professional engineering leaders who share a commitment to connect our emerging business and government principals with the communities in which we live and work so as to collectively make Florida a better community in which to practice our profession, to live, and to prosper.

VII. SELECTION CRITERIA

In order to ensure an effective learning environment, the Florida Engineering Leadership Institute class size is limited to 40 individuals; therefore:

- preference will be given to candidates with at least 10 years of engineering-related experience, and
- preference will be given to members of the Florida Engineering Society (FES) or employees of firms that are members of the Florida Institute of Consulting Engineers (FICE)

VIII. TUITION

The cost of The Florida Engineering Leadership Institute is \$4,000 per participant (not including travel, lodging, and some meals), payable to Florida Engineering Society upon acceptance to the program and prior to the first session. Tuition is non-refundable.

Tuition for applicants who are not members of the Florida Engineering Society will be increased by the amount of membership enrollment, not to exceed an additional \$350 (membership dues vary based upon chapter assignment, etc.).

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2017 Class Schedule

<u>Session / Date</u>	<u>City</u>	<u>Hotel</u>
Session I November 3-5, 2016	Tampa	<i>tbd</i>
Session II January 12-14, 2017	Orlando	<i>tbd</i>
Session III February 2017 (in conjunction with PE Legislative Days)	Tallahassee	<i>tbd</i>
Session IV March 30-April 1, 2017	Jacksonville	<i>tbd</i>
Session V June 8-10, 2017	Miami	<i>tbd</i>
Session VI August 3-5, 2017 (in conjunction with FES/FICE Annual Conference)	Palm Beach	The Breakers

IX. COMMITMENT

I understand the purpose of The Florida Engineering Leadership Institute, and if I am selected I will devote the time and resources necessary to complete the program. I understand that the first two-day session is mandatory.

I understand that even though emergencies do arise, any participant missing more than four one-half day segments, for whatever reason, will be asked to withdraw from the program and no portion of the tuition shall be refunded.

I have the full support of my employer for the time required to participate.

I further understand that The Florida Engineering Leadership Institute extends beyond the year-long program to a lifetime of opportunity for involvement. I understand that being an active participant will allow me to continue participation in the projects and programs of the Institute.

I agree to be bound by the above commitments in signing this application.

Signature of Applicant

Date